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DS3680 Quad Negative Voltage Relay Driver

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General Description

The DS3680 is a quad high voltage negative relay driver designed to operate over wide ranges of supply voltage, common-mode voltage, and ambient temperature, with 50 mA sink capability. These drivers are intended for switching the ground end of loads which are directly connected to the negative supply, such as in telephone relay systems.

Since there may be considerable noise and IR drop between logic ground and negative supply ground in many applications, these drivers are designed to operate with a high common-mode range ($\pm 20V$ referenced to negative supply ground). Each driver has a common-mode range separate from the other drivers in the package, which pemits input signals from more than one element of the system.

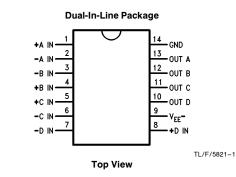
With low differential input current requirements (typically 100 μ A), these drivers are compatible with TTL, LS and CMOS logic. Differential inputs permit either inverting or non-inverting operation.

The driver outputs incorporate transient suppression clamp networks, which eliminate the need for external networks when used in applications of switching inductive loads. A fail-safe feature is incorporated to insure that, if the +INinput or both inputs are open, the driver will be OFF.

Features

- -10V to -60V operation
- Quad 50 mA sink capability
- TTL/LS/COMS or voltage comparator input
- High input common-mode voltage range
- Very low input current
- Fail-safe disconnect feature
- Built-in output clamp diode

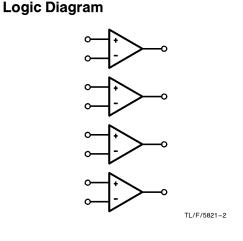
Connection Diagram



Order Number DS3680J, DS3680M or DS3680N See NS Package Number J14A, M14A, N14A

Truth Table

Differential Inputs	Outputs
$V_{\text{ID}} \geq 2V$	On
$V_{\text{ID}} \leq 0.8 V$	Off
Open	Off



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Absolute Maximum Ratings (Note 1)

Supply Voltage (GND to V_{EE} -, and Any Pin)

Positive Input Voltage (Input to GND)

Differential Voltage (+IN to -IN)

Inductive Load

Output Current

Storage Temperature

Cavity Package

SO Package

Molded Dip Package

Negative Input Voltage (Input to V_{FF}-)

Maximum Power Dissipation* at 25°C

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (GND to V _{EE} -)	-10	-60	V
Input Voltage (Input to GND)	-20	20	V
Logic ON Voltage (+IN)			
Referenced to -IN	2	20	V
Logic OFF Voltage (+IN)			
Referenced to -IN	-20	0.8	V
Temperature Range	-25	+85	°C

Lead Temperature (Soldering, 4 seconds) 260°C * Derate cavity package 9.6 mW/°C above 25°C; derate molded dip pack-age 11.2 mW/°C above 25°C; derate SO package 8.02 mW/°C above 25°C.

Electrical Characteristics (Notes 2 and 3)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
VIH	Logic "1" Input Voltage		2.0	1.3		V
V _{IL}	Logic "0" Input Voltage			1.3	0.8	V
I _{INH}	Logic "1" Input Current	$V_{IN} = 2V$ $V_{IN} = 7V$		40 375	100 1000	μΑ μΑ
I _{INL}	Logic "0" Input Current	$V_{IN} = 0.4V$ $V_{IN} = -7V$		-0.01 -1	-5 -100	μA μA
V _{OL}	Output ON Voltage	$I_{OL} = 50 \text{ mA}$		- 1.6	-2.1	V
I _{OFF}	Output Leakage	$V_{OUT} = V_{EE} -$		-2	-100	μΑ
I _{FS}	Fail-Safe Output Leakage	V _{OUT} = V _{EE} (Inputs Open)		-2	-100	μΑ
ILC	Output Clamp Leakage Current	V _{OUT} = GND		2	100	μΑ
V _C	Output Clamp Voltage	$I_{CLAMP} = -50 \text{ mA}$ Referenced to V _{EE} -		-2	-1.2	v
VP	Positive Output Clamp Voltage	I _{CLAMP} = 50 mA Referenced to GND		0.9	1.2	v
I _{EE(ON)}	ON Supply Current	All Drivers ON		-2	-4.4	mA
I _{EE(OFF)}	OFF Supply Current	All Drivers OFF		-1	-100	μΑ
t _{PD(ON)}	Propagation Delay to Driver ON	$\begin{array}{l} L=1h,R_{L}=1k,\\ V_{IN}=3VPulse \end{array}$		1	10	μs
t _{PD(OFF)}	Propagation Delay to Driver OFF	$\begin{array}{l} L=1h,R_{L}=1k,\\ V_{IN}=3VPulse \end{array}$		1	10	μs

-70V

20V

-5V

 $\pm 20V$

 $L_L \leq 5h$ $I_L \le 50 \text{ mA}$

-100 mA

1433 mW

1398 mW

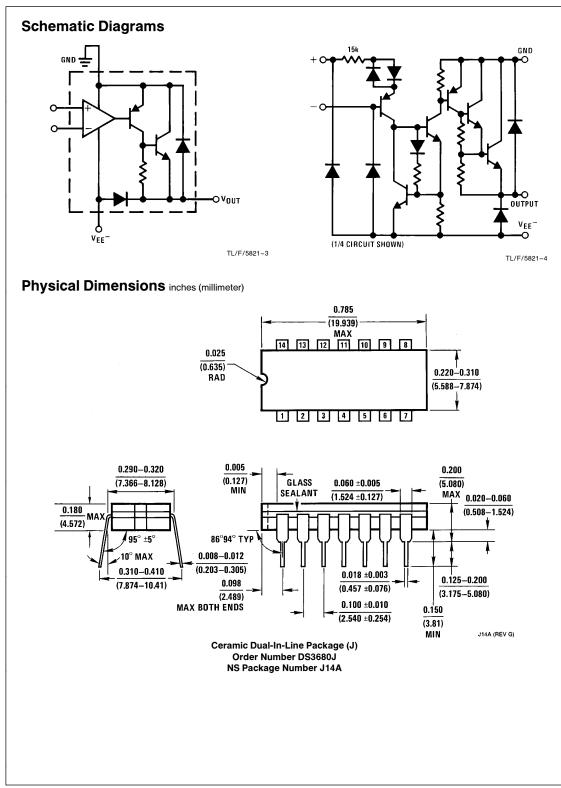
1002 mW

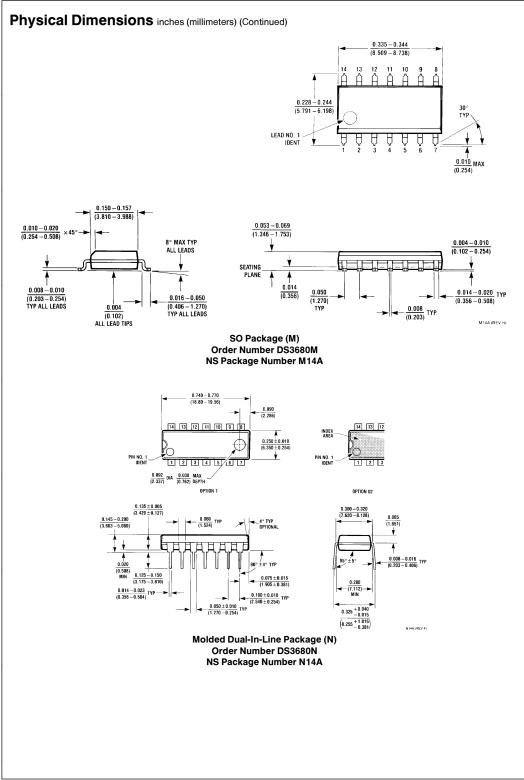
 $-65^{\circ}C$ to $+150^{\circ}C$

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range", they are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Unless otherwise specified, the min/max limits of the table of "Electrical Characteristics" apply within the range of the table of "Operating Conditions". All typical values are given for $V_{\mbox{EE}}{}^-$ = 52V, and $T_{\mbox{A}}$ = 25°C.

Note 3: All current into device pins shown as positive, out of the device as negative. All voltages are referenced to ground unless otherwise noted.





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